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# Selected Papers from ICI2017 and Spintech Thesis Awards

Guest Editor:

## Prof. Dr. Chien-Hung Liu

Department of Mechanical Engineering, National Chung Hsing University, 250 Kuo Kuang Rd., Taichung 402, Taiwan

Deadline for manuscript submissions: closed (28 February 2018) Dear Colleagues,

Message from the Guest Editor

This Special Issue will select the papers from ICI2017 (2017 3rd International Conference on Inventions, http://sciforum.net/conference/ICI2017) and Spintech Thesis Awards. The aims and scope of the 2017 3rd International Conference on Inventions is to make researchers focus on patent-based research. Papers with innovative ideas in all aspects of science and engineering are also encouraged in this Special Issue.

Prof. Dr. Chien-Hung Liu *Guest Editor* 









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#### Prof. Dr. Chien-Hung Liu

Department of Mechanical Engineering, National Chung Hsing University, 250 Kuo Kuang Rd., Taichung 402, Taiwan

#### Prof. Dr. Shoou-Jinn Chang

Department of Electrical Engineering, National Cheng Kung University, Tainan 701, Taiwan

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